

#### **Vishay Siliconix**

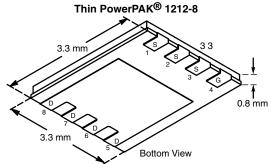
RoHS

COMPLIANT

HALOGEN

## P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
	0.0040 at V <sub>GS</sub> = - 10 V	- 35 <sup>a</sup>			
- 20	0.0055 at V <sub>GS</sub> = - 4.5 V	- 35 <sup>a</sup>	55.5 nC		
	0.0095 at V <sub>GS</sub> = - 2.5 V	- 35 <sup>a</sup>			

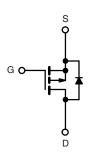


#### **FEATURES**

- TrenchFET<sup>®</sup> Gen III P-Channel Power MOSFET
- Thin 0.8 mm max. height
- 100 % R<sub>q</sub> and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Smart Phones, Tablet PCs, and Mobile Computing
  - Battery Switch
  - Load Switch
  - Power Management



P-Channel MOSFET

Unit

°C/W

Ordering Information:

SiS415DNT-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	v	
	T <sub>C</sub> = 25 °C		- 35 <sup>a</sup>	A	
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C		- 35 <sup>a</sup>		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 22.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 18.2 <sup>b, c</sup>		
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	- 80	1 ^	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	L.	- 35 <sup>a</sup>	_	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 3.3 <sup>b, c</sup>		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 20		
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		52		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	33	w	
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	FD	3.7 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		2.4 <sup>b, c</sup>	7	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	<u></u>	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

# THERMAL RESISTANCE RATINGSParameterSymbolTypicalMaximumMaximum Junction-to-Ambient<sup>b, f</sup> $t \le 10$ s $R_{thJA}$ 2633Maximum Junction-to-Case (Drain)Steady State $R_{thJC}$ 1.92.4

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 81 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	<u> </u>			<u> </u>	<u> </u>		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 0504		- 14		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μΑ		3.1			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.4		- 1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
7		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 V, V_{GS} = -10 V$	- 30			Α	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 20 A		0.0033	0.0040		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -15 \text{ A}$		0.0044	0.0055	Ω	
	()	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 10 A		0.0076	0.0095	-	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 20 A		70		S	
Dynamic <sup>b</sup>				1			
Input Capacitance	C <sub>iss</sub>			5460			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		645		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			642			
-	Q <sub>g</sub> Q <sub>gs</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		117	180		
Total Gate Charge				55.5	85	nC	
Gate-Source Charge		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 10 A		7.9			
Gate-Drain Charge	Q <sub>gd</sub>			12.7			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	2.2	4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			37	70		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, \text{ R}_{1} = 1 \Omega$		38	70		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 10 Å, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		82	150		
Fall Time	t <sub>f</sub>			25	50		
Turn-On Delay Time	t <sub>d(on)</sub>			14	25	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, \text{ R}_{1} = 1 \Omega$		13	25		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 10 Å, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		83	150		
Fall Time	t <sub>f</sub>	Ŭ.		14	25		
Drain-Source Body Diode Characterist				1	<u> </u>		
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 35		
Pulse Diode Forward Current	I <sub>SM</sub>			1	- 80	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 4 A, V <sub>GS</sub> = 0 V		- 0.72	- 1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			25	50	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			12	24	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F$ = - 10 A, dl/dt = 100 A/µs, $T_J$ = 25 °C		11		- ns	
Reverse Recovery Rise Time	t <sub>b</sub>			14	┨────┤		

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

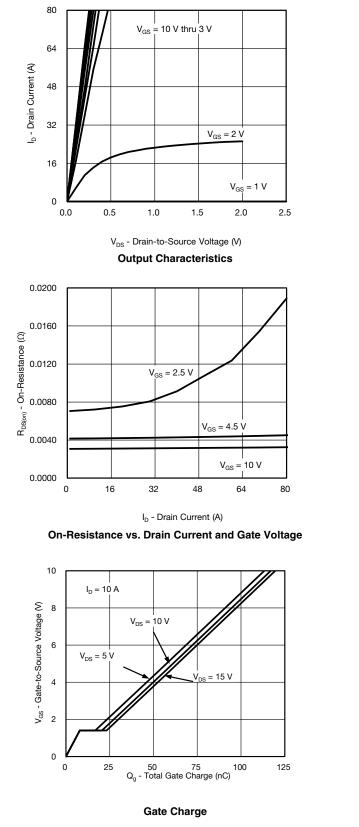
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

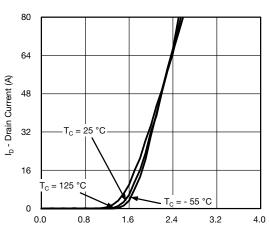
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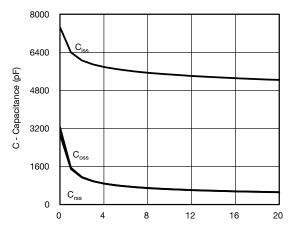
## SiS415DNT Vishay Siliconix

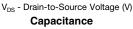
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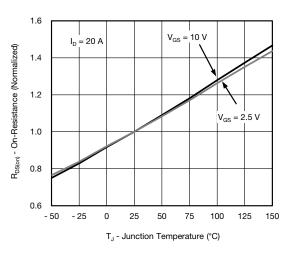




V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 







**On-Resistance vs. Junction Temperature** 

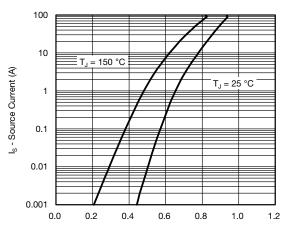
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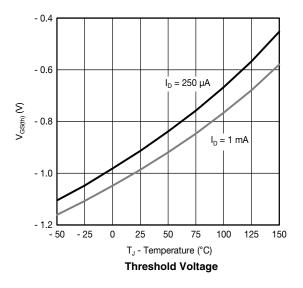
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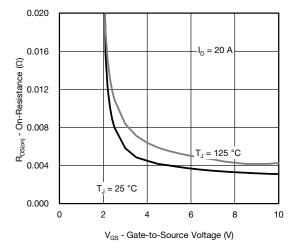
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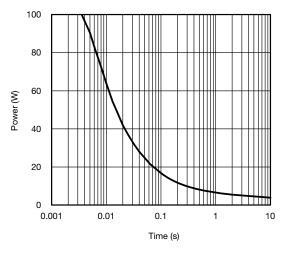
V<sub>SD</sub> - Source-to-Drain Voltage (V)



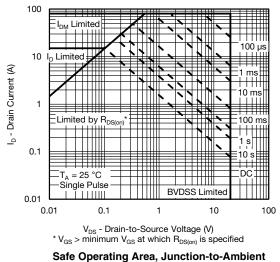




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



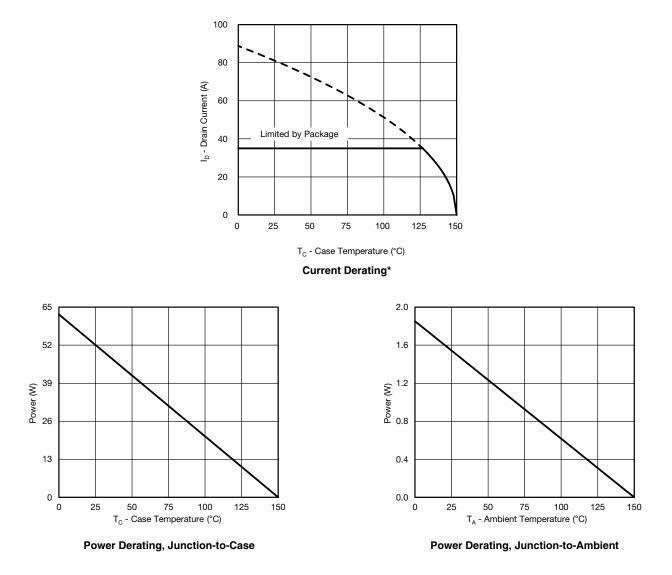
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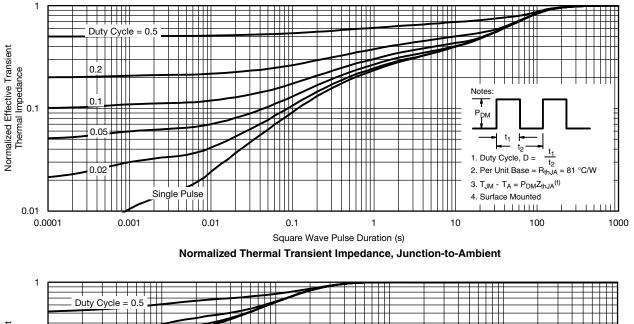


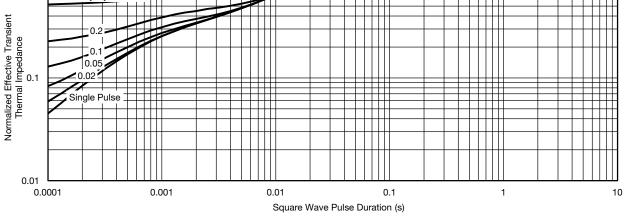
\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?63684">www.vishay.com/ppg?63684</a>.

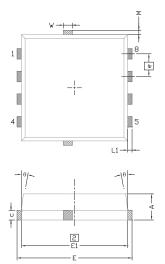
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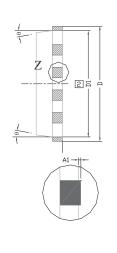
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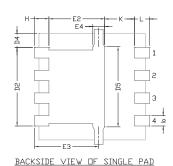


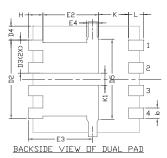
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# PowerPAK® 1212-8T









ND	TE:
	MILIMETER WILL GOVERN
	DIMENSIONS EXCLUSIVE OF MOLD GATE BURRS.
3	DIMENSIONS EXCLUSIVE OF MOLD FLASH AND CUTTING BURRS.

		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00	-	0.05	0.000	-	0.002	
b	0.23	0.30	0.41	0.009	0.012	0.016	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
D3	0.48	-	0.89	0.019	-	0.035	
D4		0.47 TYP.		0.0185 TYP.			
D5		2.3 TYP.			0.090 TYP.		
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	1.75	1.85	1.98	0.069	0.073	0.078	
E4	0.34 TYP.			0.013 TYP.			
е	0.65 BSC			0.026 BSC			
K	0.86 TYP.			0.034 TYP.			
K1	0.35	-	-	0.014	-	-	
Н	0.30	0.41	0.51	0.012	0.016	0.020	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 TYP.			0.005 TYP.			
J: T13-0056-R	ev. A, 18-Feb-13			•			

Revison: 18-Feb-13



Vishay

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